RF Transformer

-40°C to 85°C

-55°C to 100°C

 50Ω

DC Current

1.5 to 500 MHz

30mA

Features

- · leadless surface mount
- · good return loss
- usable over 0.4-500 MHz
- excellent amplitude unbalance, 0.1 dB typ. and phase unbalance, 2 deg typ. in 1 dB bandwidth
- aqueous washable

Applications

- balanced to unbalanced transformation

CASE STYLE: AT224 PRICE: Contact Sales Dept.

Pin Connections

Maximum Ratings

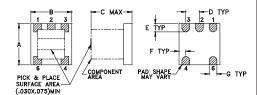
Operating Temperature

Storage Temperature

PRIMARY DOT	6
PRIMARY	4
SECONDARY DOT	1
SECONDARY	3
NOT USED	2

Permanent damage may occur if any of these limits are exceeded.

Outline Drawing AT224



PCB Land Pattern



Suggested Layout,

• push-pull amplifiers

Transformer Electrical Specifications

Ω RATIO	FREQUENCY (MHz)	3 dB	INSERTION LOSS*	1 dB
		MHz	MHz	MHz
1	1.5-500	1.5-500	2.5-400	5-350

^{*} Insertion Loss is referenced to mid-band loss, 0.6 dB tvp.

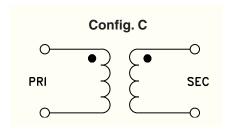
NON-CATALOG

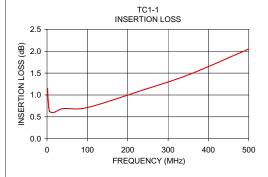
Typical Performance Data

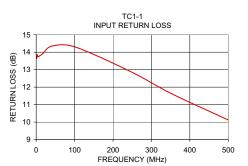
FREQUENCY (MHz)	INSERTION LOSS (dB)	INPUT R. LOSS (dB)	
1.51	1.15	13.64	
2.49	0.91	13.85	
4.35	0.72	13.75	
6.87	0.62	13.76	
16.75	0.60	13.91	
40.86	0.69	14.35	
99.67	0.71	14.31	
243.10	1.13	12.92	
353.08	1.47	11.62	
502.30	2.06	10.10	

Outline Dimensions (inch)

F	E	D	С	В	Α
.025	.030	.050	.150	.150	.150
0.64	0.76	1.27	3.81	3.81	3.81
wt		K	J	Н	G
grams		.030	.190	.065	.028
0.10		0.76	4.83	1.65	0.71







For detailed performance specs



RF Transformer TC1-1

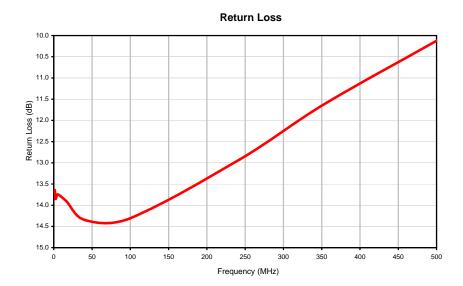
Typical Performance Data

FREQUENCY (MHz)	INSERTION LOSS (dB)	RETURN LOSS (dB)
1.51	1.15	13.64
2.49	0.91	13.85
4.35	0.72	13.75
6.87	0.62	13.76
16.75	0.60	13.91
40.86	0.69	14.35
99.67	0.71	14.31
243.10	1.13	12.92
353.08	1.47	11.62
502.30	2.06	10.10

RF Transformer TC1-1

Typical Performance Curves

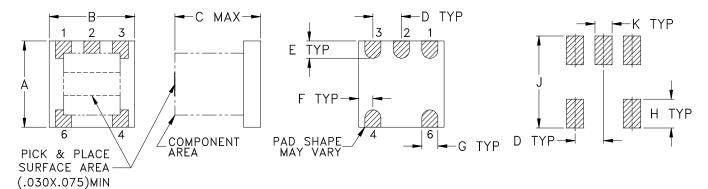




Outline Dimensions

AT224

PCB Land Pattern



Suggested Layout, Tolerance to be within ±.002

CASE #	A	В	C	D	Е	F	G	Н	J	K	L	WT. GRAMS
AT224	.150 (3.81)	.150 (3.81)	.150 (3.81)	.050 (1.27)	.030 (0.76)	.025 (0.64)	.028 (0.71)	.065 (1.65)	.190 (4.83)	.030 (0.76)		.10

Dimensions are in inches (mm). Tolerances: 2 Pl. \pm .01; 3 Pl. \pm .005

Notes:

- 1. Open style, ceramic base.
- 2. Termination finish:

For RoHS Case Styles: 2-10 μ inch (.05-.25 microns) Gold over 100-300 μ inch (2.54-7.62 microns) Nickel plate. All models, (+) suffix.

For RoHS-5 Case Styles: Tin-Lead plate. All models, no (+) suffix.



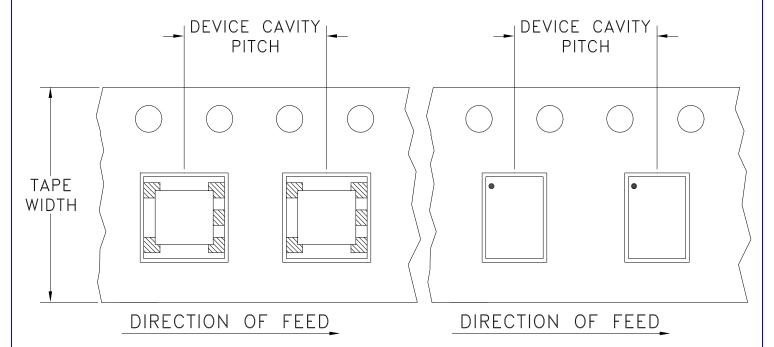


P.O. Box 350166, Brooklyn, New York 11235-0003 (718) 934-4500 Fax (718) 332-4661 For detailed performance specs & shopping online see Mini-Circuits we'b site

The Design Engineers Search Engine Provides ACTUAL Data Instantly From MINI-CIRCUITS At: www.minicircuits.com

Tape & Reel Packaging TR-F17

DEVICE ORIENTATION IN T&R



Tape Width,	Device Cavity	Reel Size,	Devices	s per Reel
mm	Pitch, mm	inches		
			Small	20
			quantity	50
		7	standards	100
12	8		(see note)	200
				500
		12	Ctandard	1000
		13	Standard	2000

Note: Please Consult individual model data sheet to determine device per reel availability.

Mini-Circuits carrier tape materials provide protection from ESD (Electro-Static Discharge) during handling and transportation. Tapes are static dissipative and comply with industry standards EIA-481/EIA-541.

Go to: www.minicircuits.com/pages/pdfs/tape.pdf





P.O. Box 350166, Brooklyn, New York 11235-0003 (718) 934-4500 Fax (718) 332-4661 For detailed performance specs & shopping online see Mini-Circuits web site

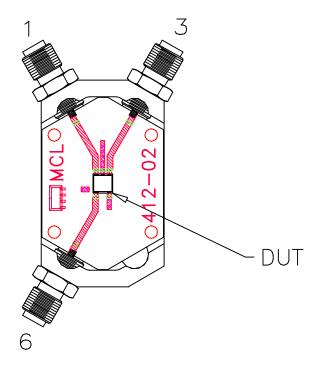
The Design Engineers Search Engine Provides ACTUAL Data Instantly From MINI-CIRCUITS At: www.minicircuits.com
RF/IF MICROWAVE COMPONENTS:

98-TR- Rev.: C (02/13/18) M166283 File: 98-TR-F17.docx

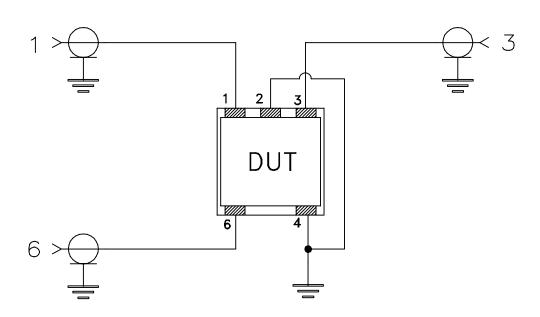
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Evaluation Board and Circuit

For Pin Connections refer to Data Sheet of the DUT



TB-145



Schematic Diagram

Notes:

- 1. 50 Ohm SMA Female connectors.
- 2. PCB Material: Rogers RO4350B or its equivalent, III Mini-Circuits® Dielectric Constant=3.5, Thickness=.020"



Environmental Specifications

ENV02T1

All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-40° to 85°C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 100° C Ambient Environment	Individual Model Data Sheet
Humidity	90 to 95% RH, 240 hours, 50°C	MIL-STD-202, Method 103, Condition A, Except 50°C and end-point electrical test done within 12 hours
Thermal Shock	-55° to 100°C, 100 cycles	MIL-STD-202, Method 107, Condition A-3, except +100°C
Solder Reflow Heat	Sn-Pb Eutetic Process: 225°C peak Pb-Free Process 245° - 250°C peak	J-STD-020, Table 4-1, 4-2 and 5-2, Figure 5-1
Solderability	10X Magnification	J-STD-002, 95% Coverage
Vibration (High Frequency)	20g peak, 10-2000 Hz, 12 times in each of three perpendicular directions (total 36)	MIL-STD-202, Method 204, Condition D
Mechanical Shock	50g, 11 ms, 1/2-sine, 18 shocks: 3 each direction, each of 3 axes	MIL-STD-202, Method 213, Condition A
Marking Resistance to Solvents	Isopropyl alcohol + mineral spirits at 25°C; terpene defluxer at 25°C; distilled water + proylene glycol monomethyl ether + monoethanolamine at 63°C to 70°C	MIL-STD-202, Method 215

ENV02T1 Rev: B

02/25/11

M130240 File: ENV02T1.pdf

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